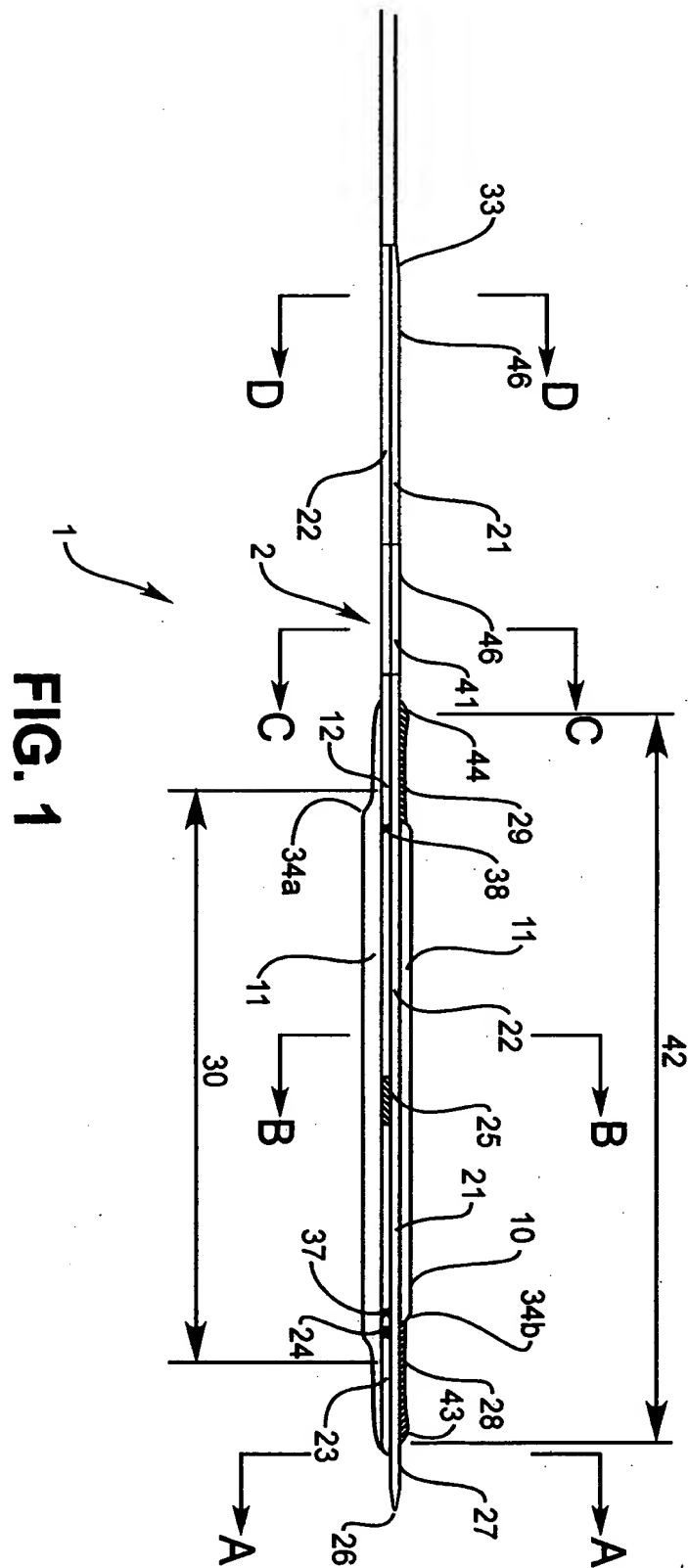


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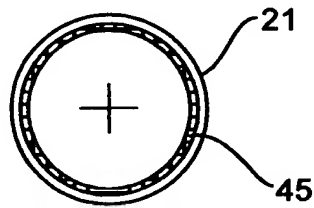


FIG. 2

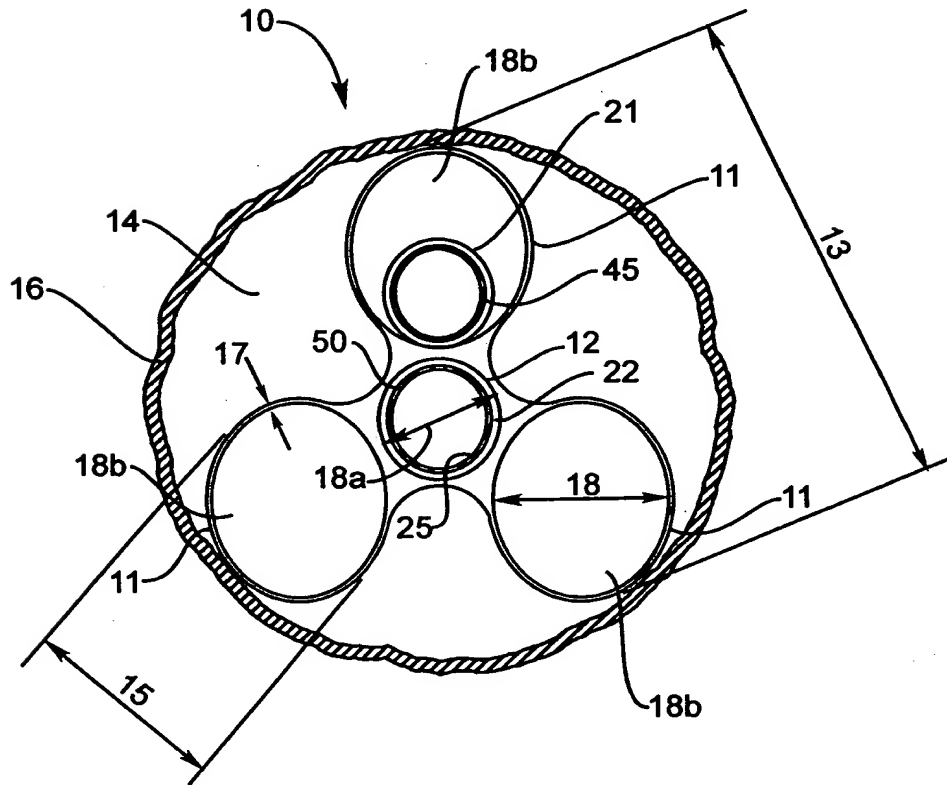


FIG. 3

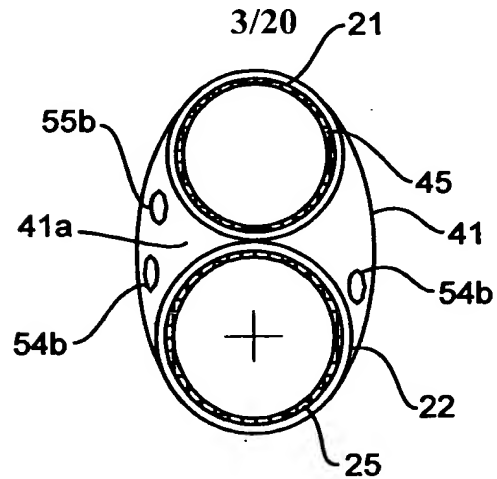


FIG. 4

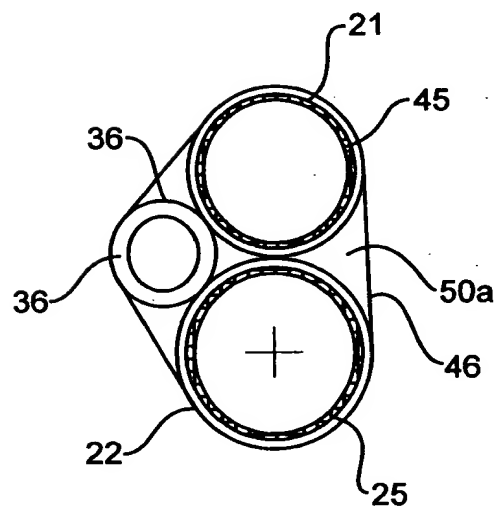


FIG. 5

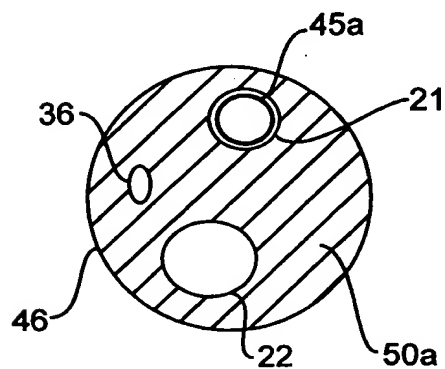
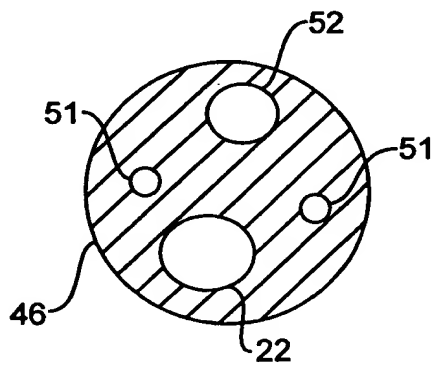
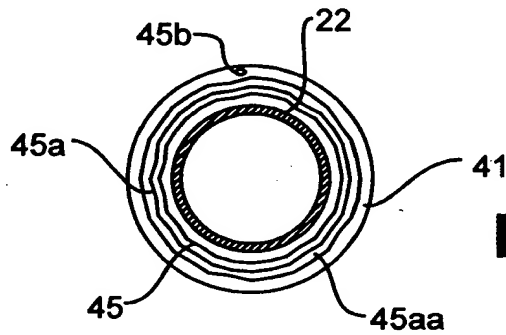
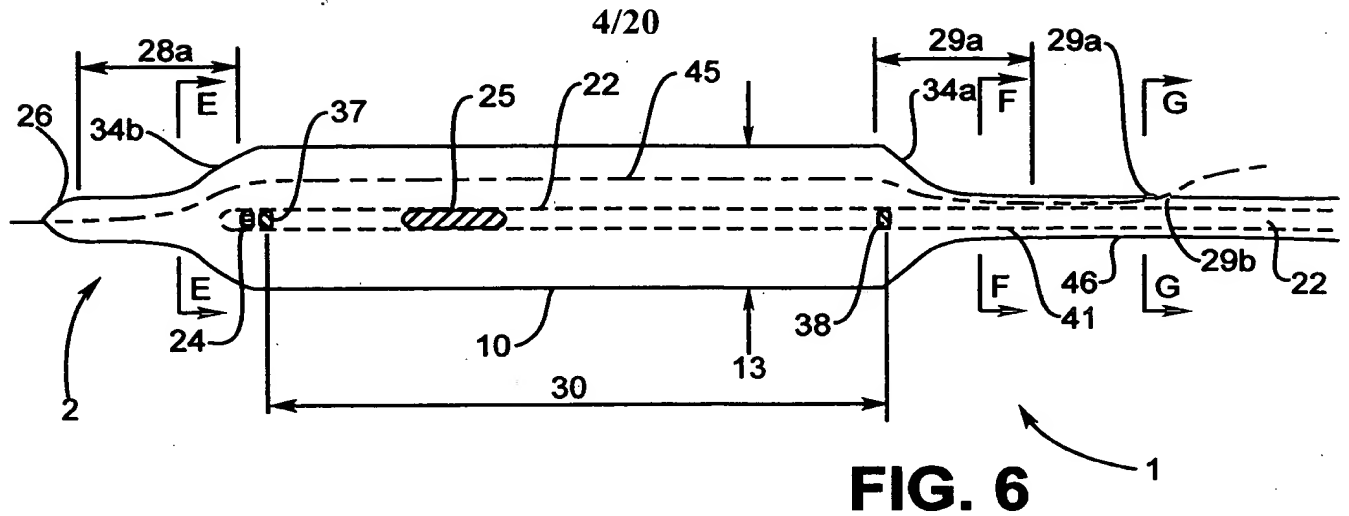
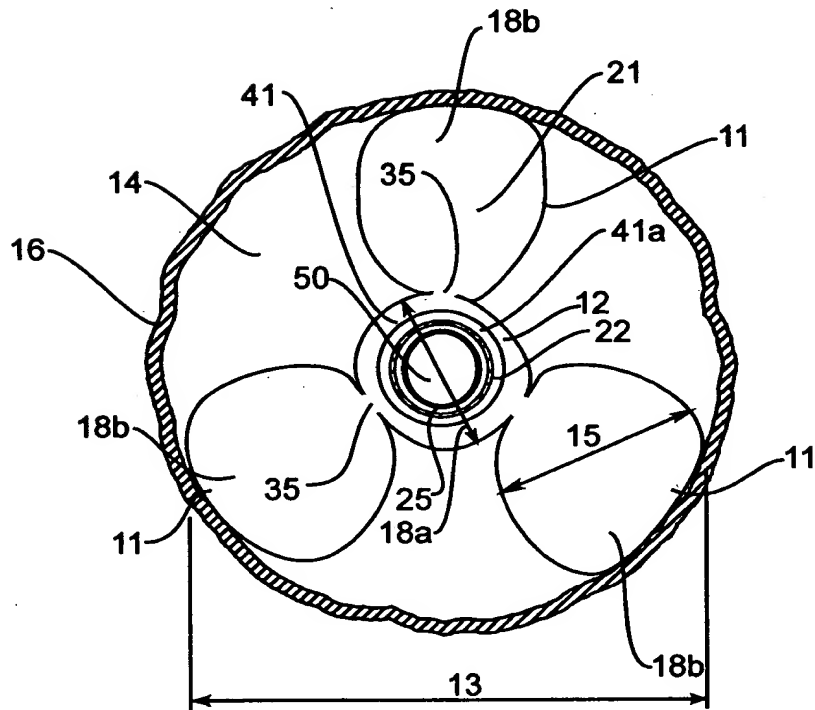


FIG. 10



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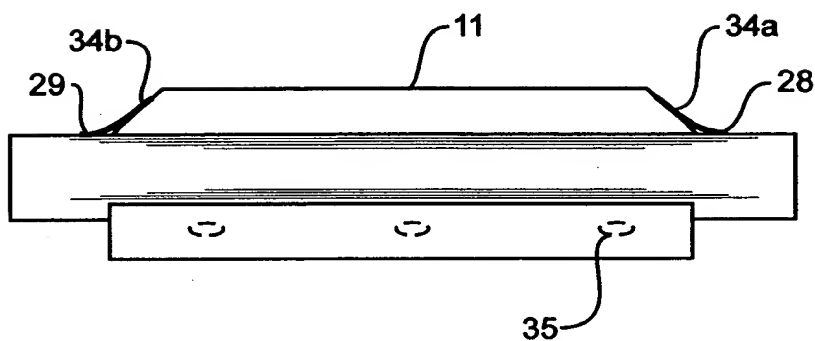
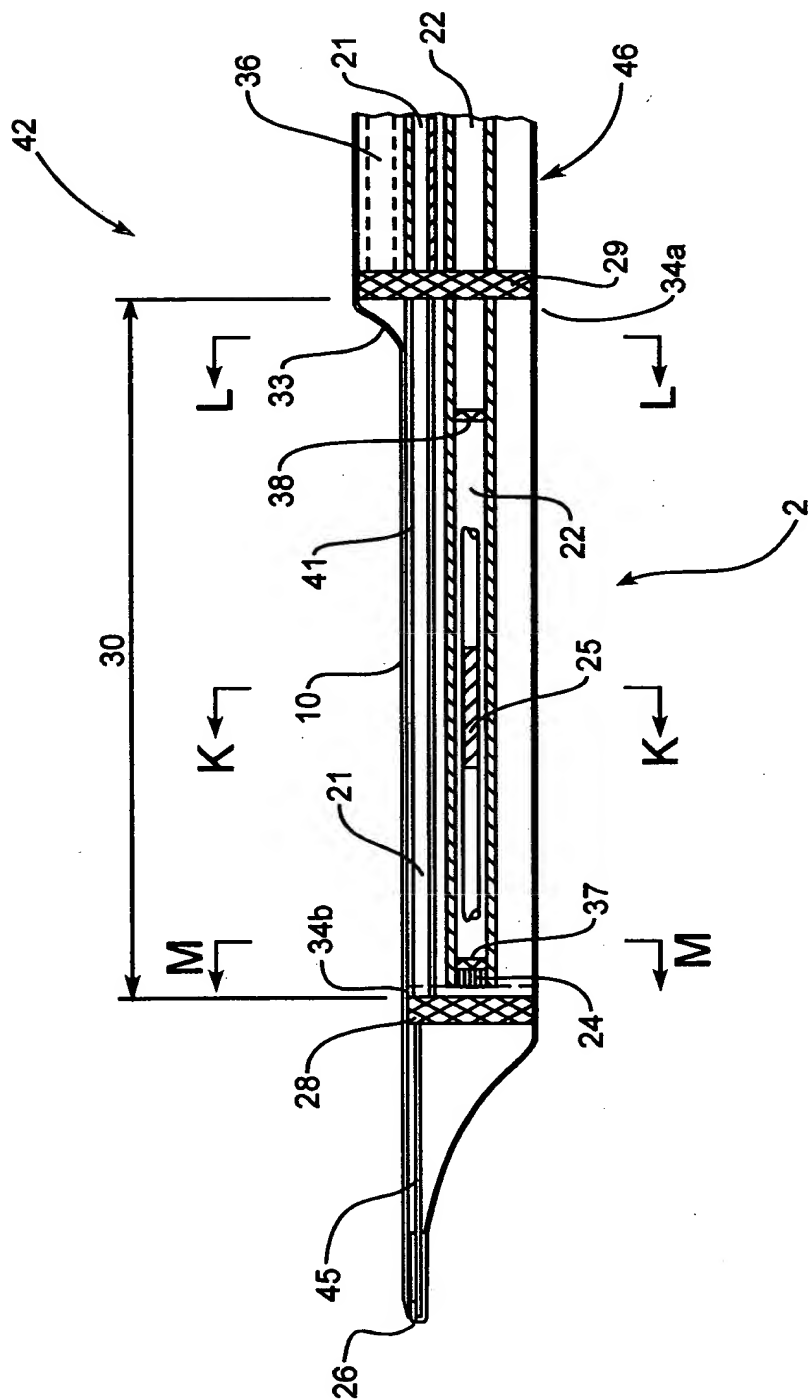


FIG. 12





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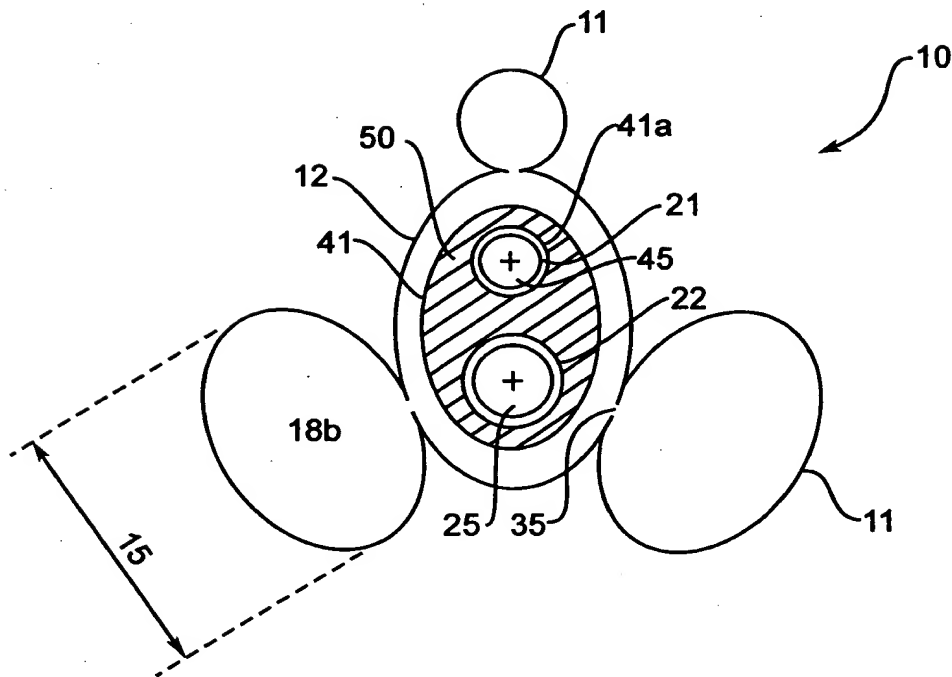


FIG. 14

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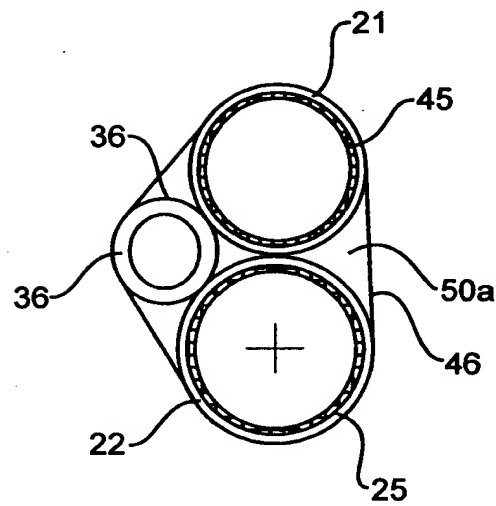
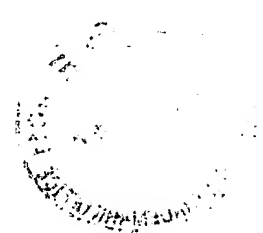


FIG. 15



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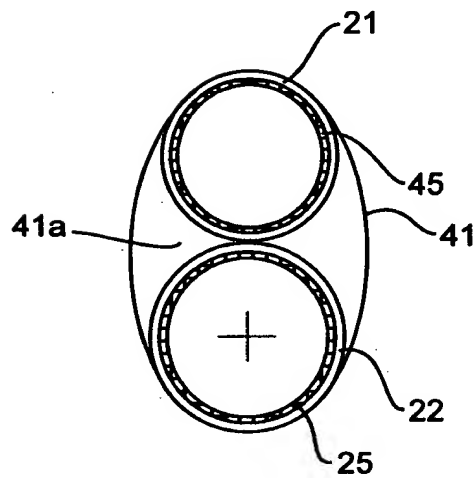
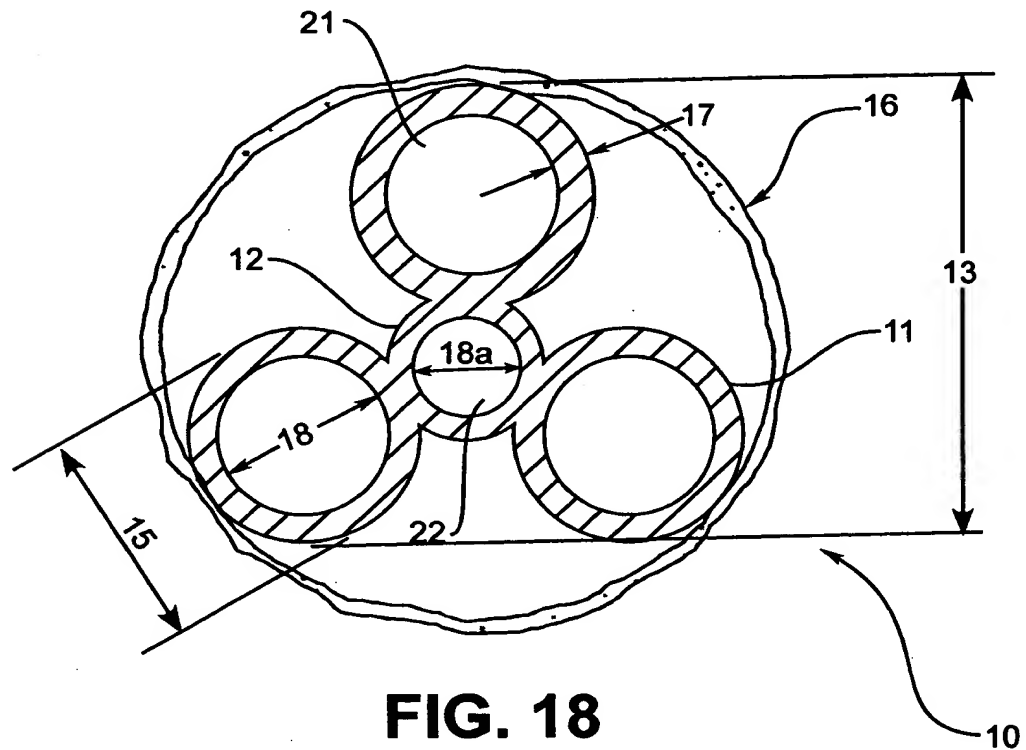
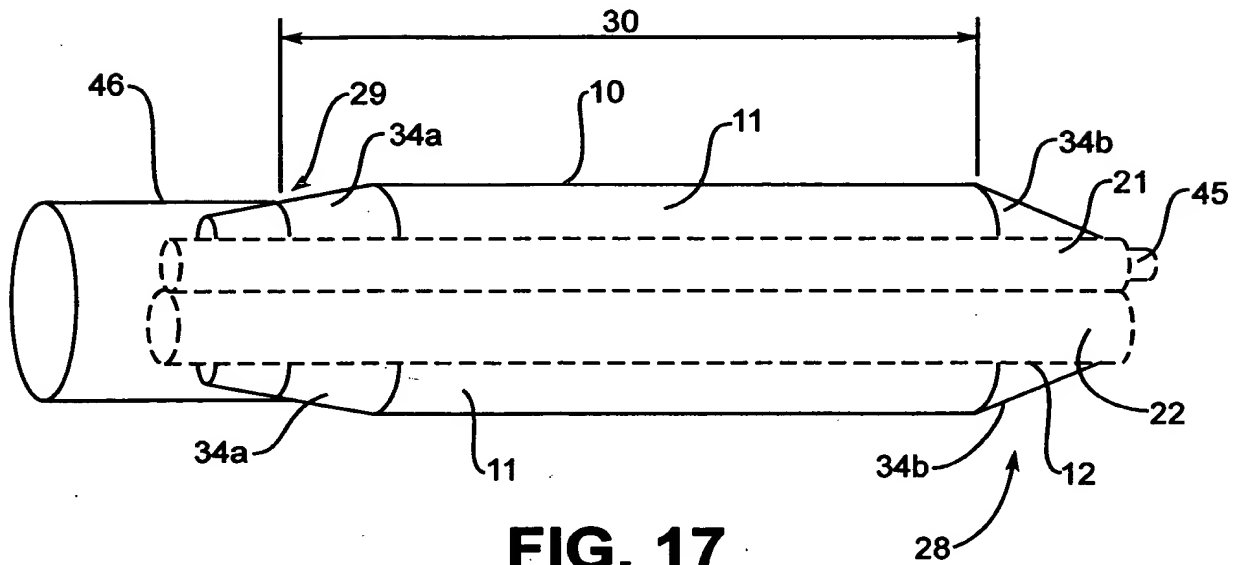


FIG. 16

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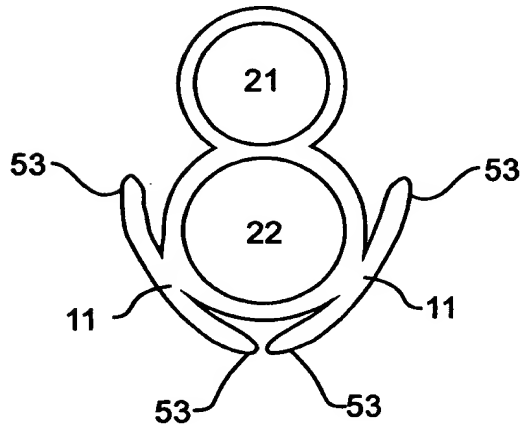


FIG. 19a

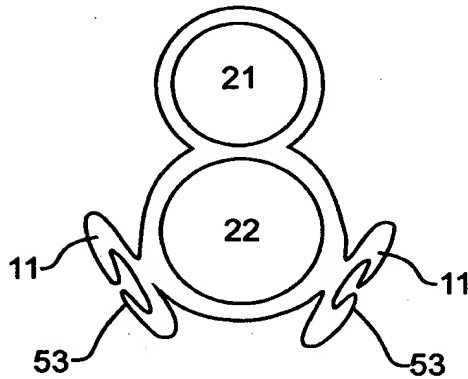


FIG. 19b

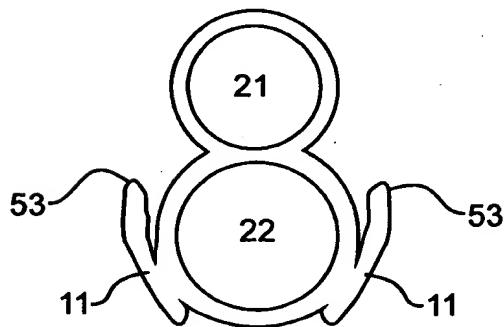


FIG. 19c



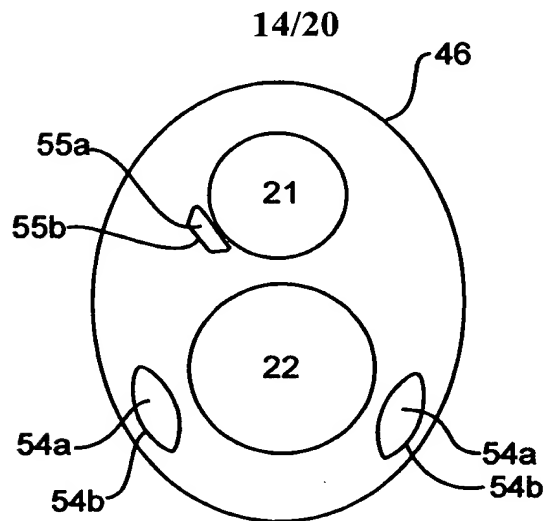


FIG. 20a

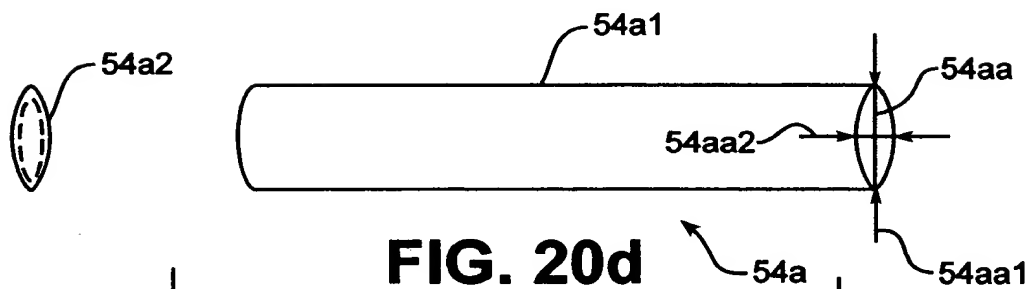


FIG. 20d

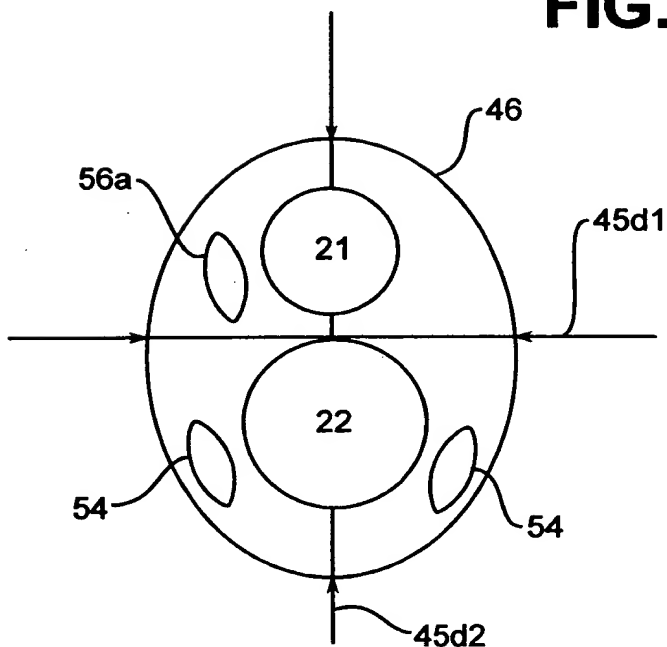


FIG. 20b

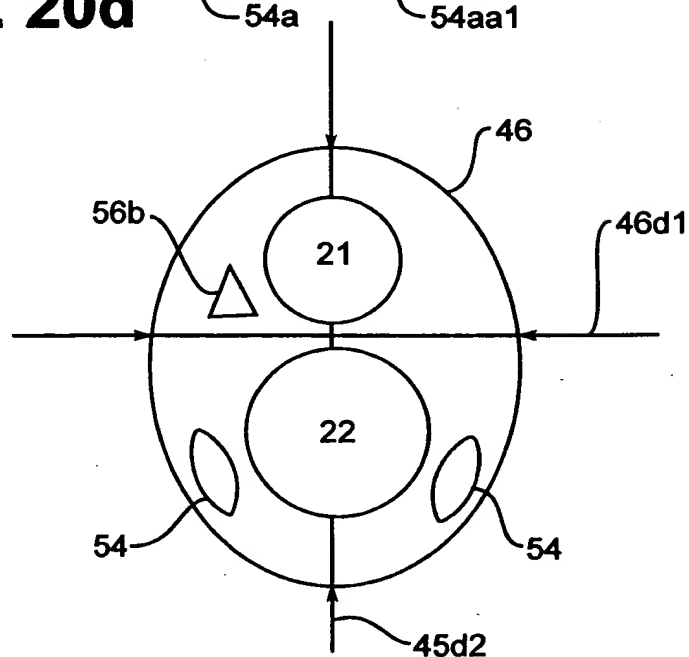


FIG. 20c

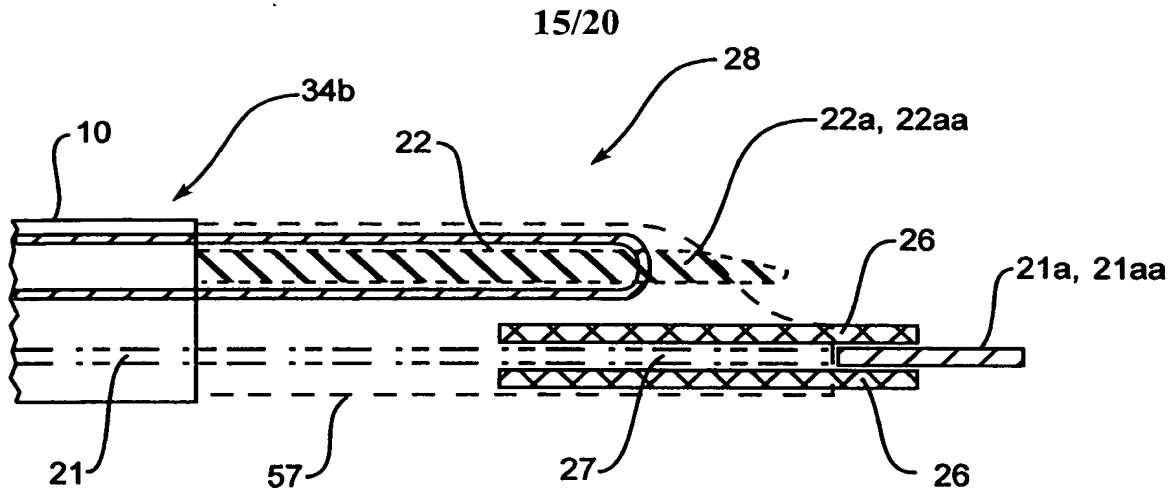


FIG. 21a

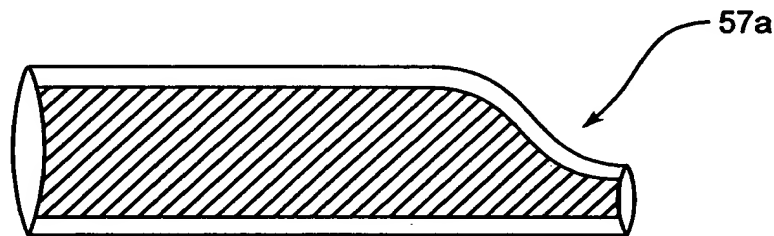


FIG. 21b

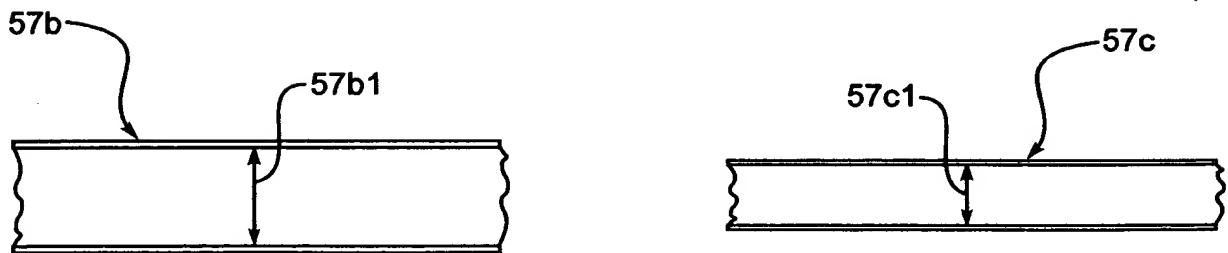


FIG. 21c



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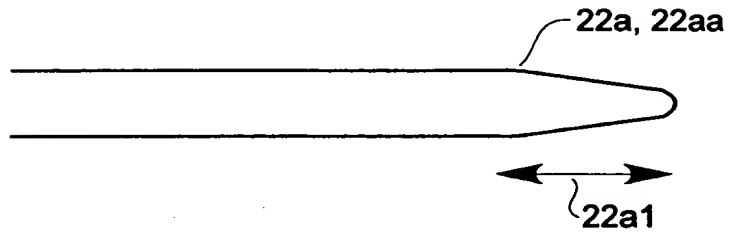


FIG. 21D

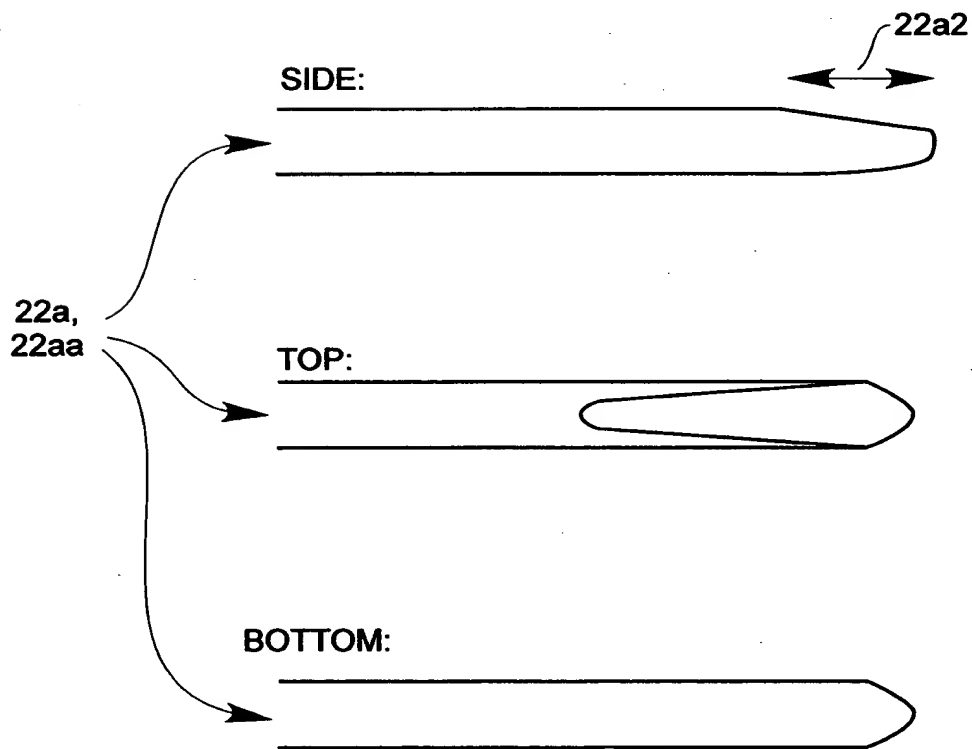


FIG. 21E



FIG. 22A

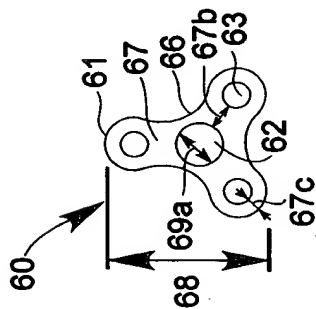


FIG. 23A

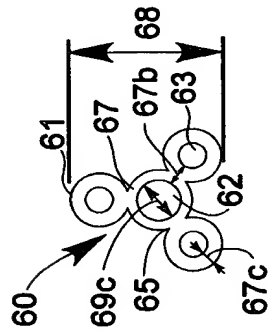


FIG. 24A

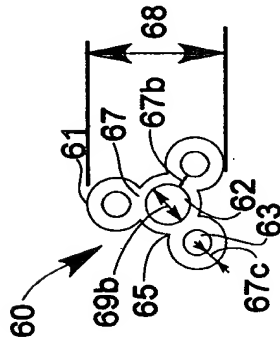


FIG. 25A

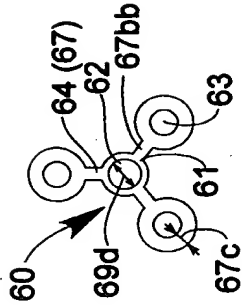


FIG. 22B

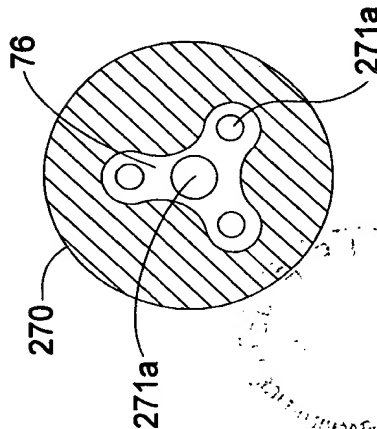


FIG. 23B

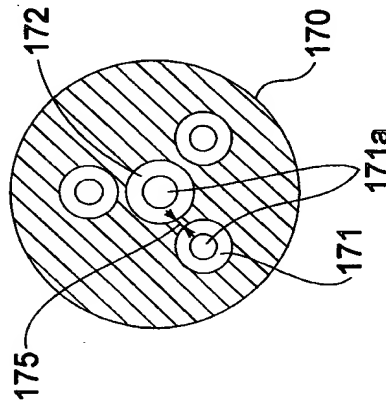


FIG. 24B

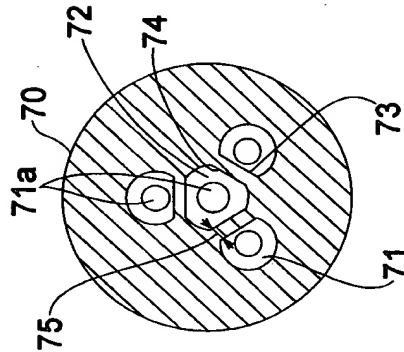
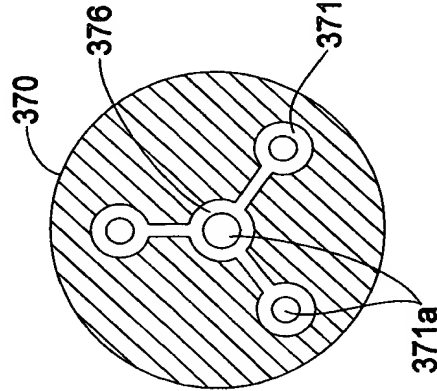


FIG. 25B



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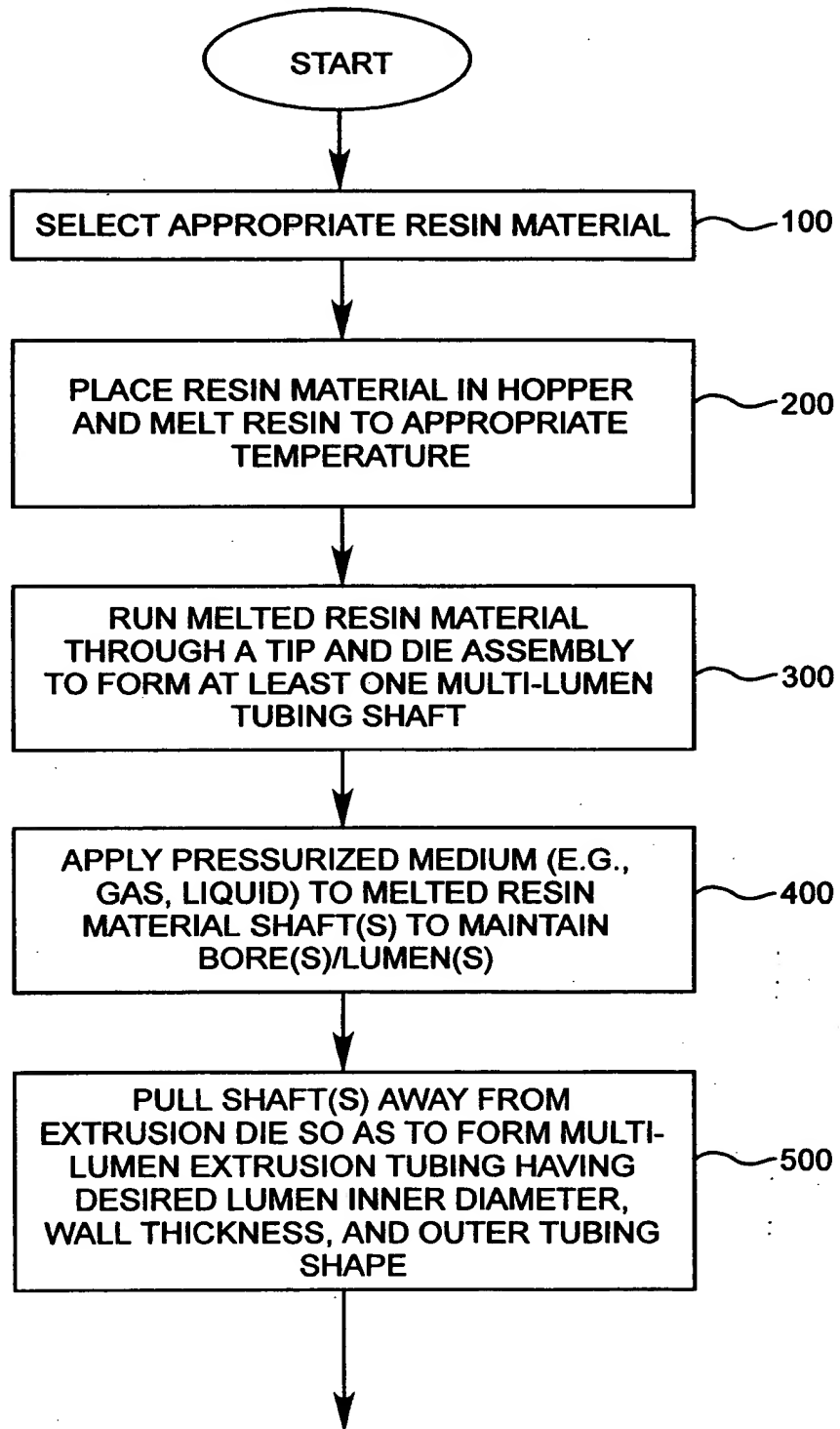


FIG. 26

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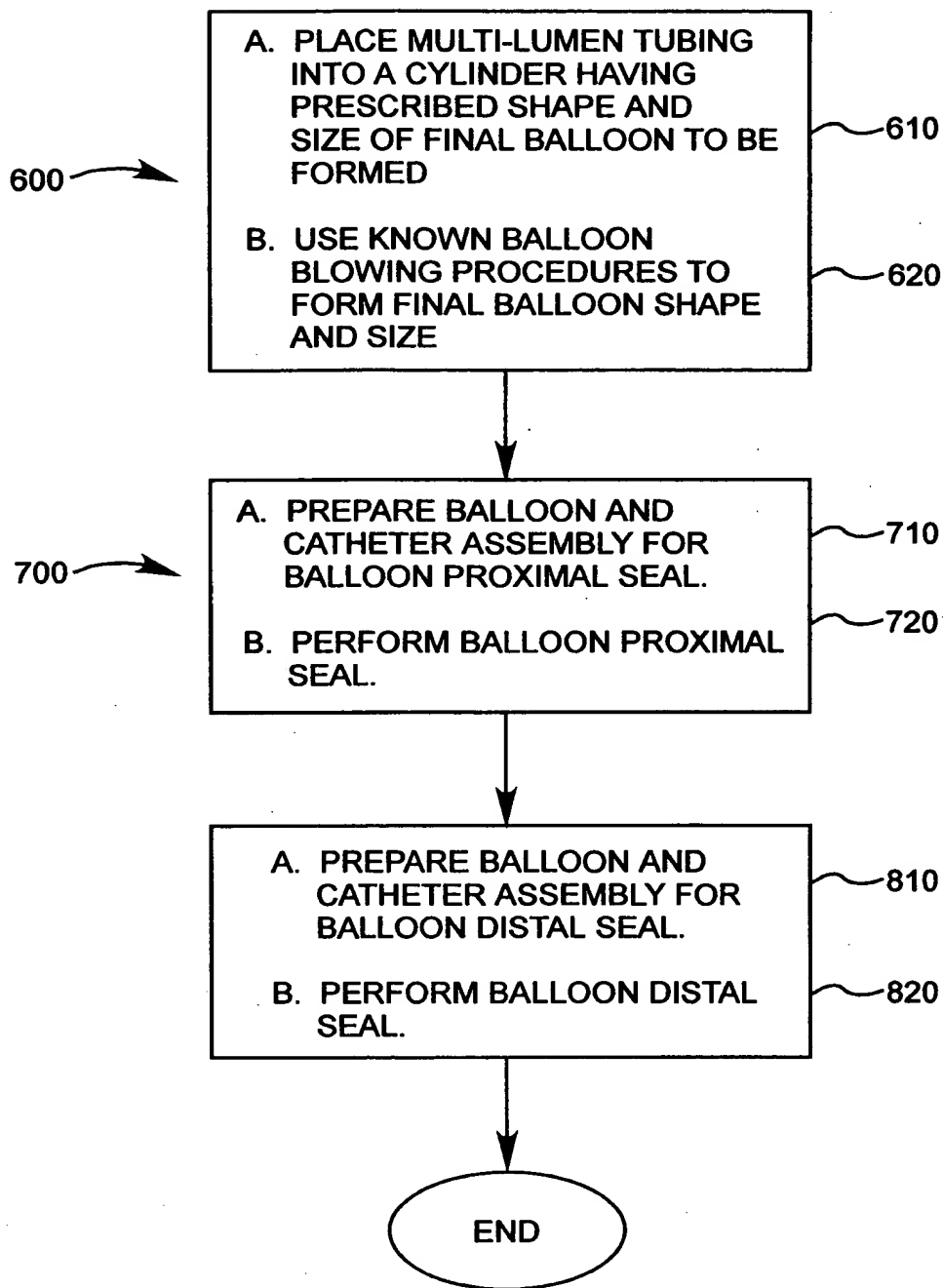


FIG. 26 (CONT.)



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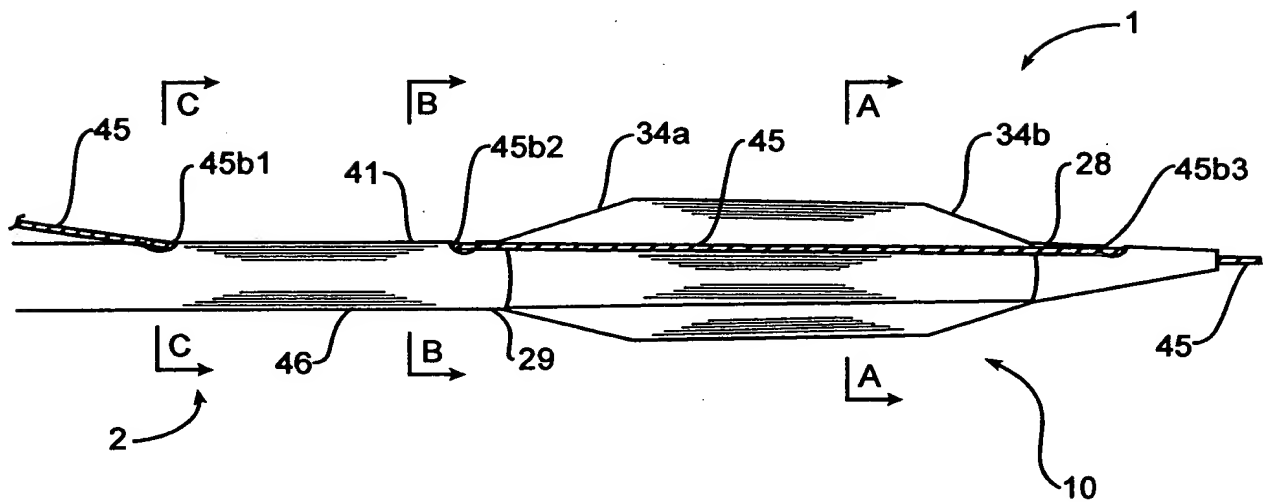


FIG. 27a

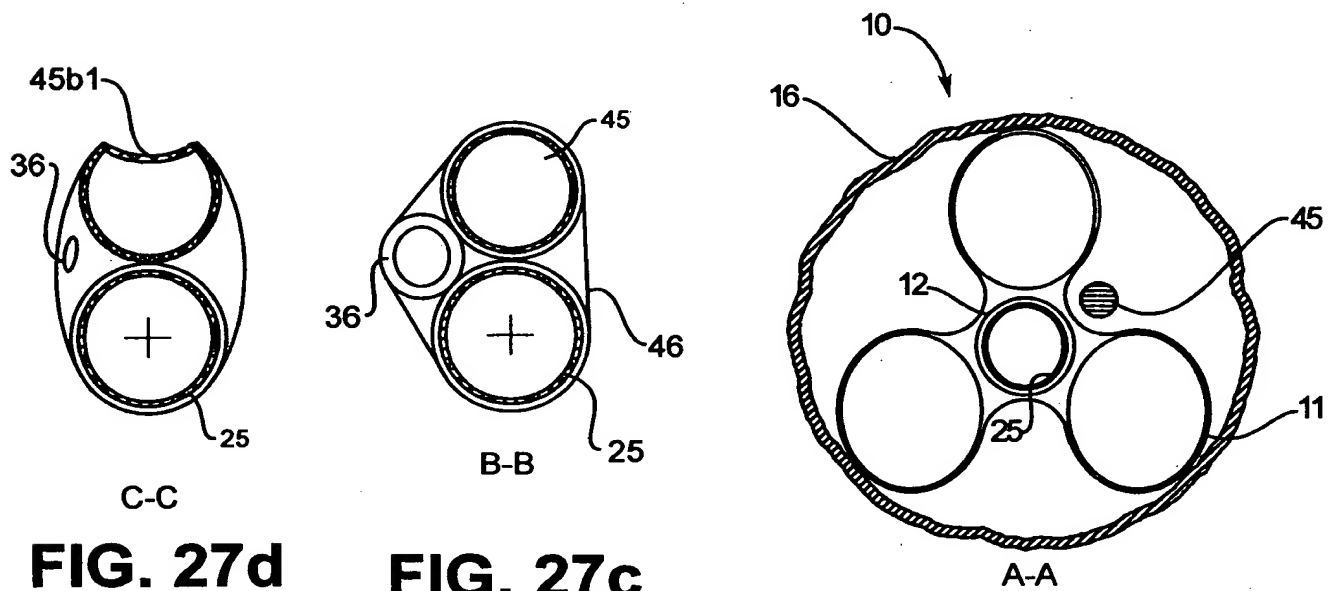


FIG. 27d

FIG. 27c

FIG. 27b

